



## Final Product/Process Change Notification

Document #:FPCN23668XA

Issue Date:20 Apr 2022

<b>Title of Change:</b>	JCAP Bumping Site Change [Batch 1]						
<b>Proposed First Ship date:</b>	27 Jul 2022 or earlier if approved by customer						
<b>Contact Information:</b>	Contact your local onsemi Sales Office or <a href="mailto:NoorArdila.Shaharuddin@onsemi.com">NoorArdila.Shaharuddin@onsemi.com</a>						
<b>PCN Samples Contact:</b>	Contact your local onsemi Sales Office. Sample requests are to be submitted no later than 30 days from the date of first notification, Initial PCN or Final PCN, for this change. Samples delivery timing will be subject to request date, sample quantity and special customer packing/label requirements.						
<b>Additional Reliability Data:</b>	Contact your local onsemi Sales Office or <a href="mailto:Nicky.Siu@onsemi.com">Nicky.Siu@onsemi.com</a>						
<b>Type of Notification:</b>	This is a Final Product/Process Change Notification (FPCN) sent to customers. FPCNs are issued 90 days prior to implementation of the change. onsemi will consider this change accepted, unless an inquiry is made in writing within 30 days of delivery of this notice. To do so, contact <a href="mailto:PCN.Support@onsemi.com">PCN.Support@onsemi.com</a> .						
<b>Marking of Parts/ Traceability of Change:</b>	Affected parts with this change will be identified by date code.						
<b>Change Category:</b>	Assembly Change						
<b>Change Sub-Category(s):</b>	Manufacturing Site Transfer						
<b>Sites Affected:</b>							
<b>onsemi Sites</b>	<b>External Foundry/Subcon Sites</b>						
None	JCAP, China						
<b>Description and Purpose:</b>							
This is the final notification of the new bump site qualification in JCET (formerly known as JCAP) of the CMF dies. The details of the changes are outlined in the tables below.							
	<table border="1"><thead><tr><th></th><th>From</th><th>To</th></tr></thead><tbody><tr><td>Bumping Site</td><td>8" wafers are processed at site B1 No.275 Binjiang Road, Jiangyin, Jiangsu, China, 214432</td><td>8" wafers are processed at site B2 No.78 Changshan Road, Jiangyin, Jiangsu, China, 214433</td></tr></tbody></table>		From	To	Bumping Site	8" wafers are processed at site B1 No.275 Binjiang Road, Jiangyin, Jiangsu, China, 214432	8" wafers are processed at site B2 No.78 Changshan Road, Jiangyin, Jiangsu, China, 214433
	From	To					
Bumping Site	8" wafers are processed at site B1 No.275 Binjiang Road, Jiangyin, Jiangsu, China, 214432	8" wafers are processed at site B2 No.78 Changshan Road, Jiangyin, Jiangsu, China, 214433					
Datasheet specifications and product electrical performance remain unchanged.							
Affected parts with this change will be identified by date code.							



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### Reliability Data Summary:

QV DEVICE NAME : EMI4193MTTAG (MY1)

RMS : S74987

PACKAGE : WDFN-16, 4x2mm, 0.5P

Test	Specification	Condition	Interval	Results
HTRB	JESD22-A108	Ta = 150°C, 100% max rated V	2016 hrs	0/231
HTSL	JESD22-A103	Ta = 150°C	1008 hrs	0/231
TC	JESD22-A104	Ta = -65°C to +150°C	1000 cycs	0/231
HAST	JESD22-A110	130°C, 85% RH, 18.8psig, bias	96 hrs	0/231
uHAST	JESD22-A118	130°C, 85% RH, 18.8psig, unbiased	96 hrs	0/231
PC	J-STD-020, JESD22-A113	MSL 1 @ 260°C	-	-
RSH	JESD22-B106	Ta = 265°C, 10 sec	-	0/30

DEVICE NAME : EMI4193MTTAG QV (TH3)

RMS : S74552

PACKAGE : WDFN-16, 4x2mm, 0.5P

Test	Specification	Condition	Interval	Results
HTRB	JESD22-A108	Ta = 150°C, 100% max rated V	1008 hrs	0/77
HTSL	JESD22-A103	Ta = 150°C	1008 hrs	0/77
TC	JESD22-A104	Ta = -65°C to +150°C	1000 cycs	0/77
HAST	JESD22-A110	130°C, 85% RH, 18.8psig, bias	96 hrs	0/77
uHAST	JESD22-A118	130°C, 85% RH, 18.8psig, unbiased	96 hrs	0/77
PC	J-STD-020, JESD22-A113	MSL 1 @ 260°C	-	-
RSH	JESD22-B106	Ta = 265°C, 10 sec	-	0/10

QV DEVICE NAME : EMI8133MUTAG (TH3)

RMS : S74989

PACKAGE : XDFN-16, 3.5x1.5mm, 0.5P

est	Specification	Condition	Interval	Results
HTRB	JESD22-A108	Ta = 150°C, 100% max rated V	2016 hrs	0/231
HTSL	JESD22-A103	Ta = 150°C	1008 hrs	0/231
TC	JESD22-A104	Ta = -65°C to +150°C	1000 cycs	0/231
HAST	JESD22-A110	130°C, 85% RH, 18.8psig, bias	96 hrs	0/231
uHAST	JESD22-A118	130°C, 85% RH, 18.8psig, unbiased	96 hrs	0/231
PC	J-STD-020, JESD22-A113	MSL 1 @ 260°C	-	-
RSH	JESD22-B106	Ta = 265°C, 10 sec	-	0/30

QV DEVICE NAME : EMI8133MUTAG (PHA)

RMS : S74554

PACKAGE : XDFN-16, 3.5x1.5mm, 0.5P

Test	Specification	Condition	Interval	Results
HTRB	JESD22-A108	Ta = 150°C, 100% max rated V	1008 hrs	0/77
HTSL	JESD22-A103	Ta = 150°C	1008 hrs	0/77
TC	JESD22-A104	Ta = -65°C to +150°C	1000 cycs	0/77
HAST	JESD22-A110	130°C, 85% RH, 18.8psig, bias	96 hrs	0/77
uHAST	JESD22-A118	130°C, 85% RH, 18.8psig, unbiased	96 hrs	0/77
PC	J-STD-020, JESD22-A113	MSL 1 @ 260°C	-	-
RSH	JESD22-B106	Ta = 265°C, 10 sec	-	0/10



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### Electrical Characteristics Summary:

Electrical characteristics are not impacted.

### List of Affected Parts:

**Note:** Only the standard (off the shelf) part numbers are listed in the parts list. Any custom parts affected by this PCN are shown in the customer specific PCN addendum in the PCN email notification, or on the **PCN Customized Portal**.

Part Number	Qualification Vehicle
CM1451-06CP	EMI4193MTTAG, EMI8133MUTAG
CM1442-08CP	EMI4193MTTAG, EMI8133MUTAG
CM1442-06CP	EMI4193MTTAG, EMI8133MUTAG
CM1422-03CP	EMI4193MTTAG, EMI8133MUTAG